ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® International and Pan	C, Bannockb	ourn, Illinois. A	Il rights reserved u ntions.	nder both	This docum level parts, t	ent is a declarati the declaration e	on of the su	bstances all lower	within the manufactur r level materials for w	er listed hich the 1	item. Note: it nanufacturer	f the item is an as has engineering	ssembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distrib				 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi 				als and Mfg Information				
Supplier Information													
Company name*	Company un	Company unique ID			Unique ID Authority				Response Date*				
onsemi										2023-06-08			
Contact Name Title - Contact			ntact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product E			duct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Rep			Representative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		umber Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type
	NLAS46	584MR2G	LOG SPDT ANALOG SWITCH			2023-06-08		N	MY1		34.72	mg	Each
Manufacturing Proccess Informat	ion												·
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base A		Alloy J	J-STD-020 MSI	L Rating	Peak Proc	ess Body Te	mperatur	e Max Time at Peak	Tempera	ture Numb	er of Reflow Cy	cles
Matte Tin (Sn) - annealed CU Alloy			1	1		260		С	30	seco	nds 3		
Comments													
level 1 - maximum time at peak temperatu	re during sol	Idering is 10-3	0 seconds										
For more information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.31	mg	Supplier	Silicon (Si)	7440-21-3		0.31	mg
Die Attach	0.91	mg		Epoxy resin	proprietary data		0.0228	mg
			Supplier	Silver (Ag)	7440-22-4		0.769	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0228	mg
			Supplier	Inorganic filler	Proprietary Data		0.0228	mg
			Supplier	Dicyandiamine	461-58-5		0.0046	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0682	mg
Lead Frame	17.82	mg	Supplier	Silver (Ag)	7440-22-4		0.4455	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0178	mg
			Supplier	Iron (Fe)	7439-89-6		0.4277	mg
			Supplier	Copper (Cu)	7440-50-8		16.929	mg
Mold Compound-Black	14.88	mg		Epoxy resin	proprietary data		0.744	mg
			Supplier	Phenolic Resin	Proprietary Data		0.744	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.2976	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0744	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		13.02	mg
Plating	0.48	mg	Supplier	Tin (Sn)	7440-31-5		0.48	mg
Wire Bond - Au	0.32	mg	Supplier	Gold (Au)	7440-57-5		0.32	mg